

P54/74FCT139/A/C (P54/74PCT139/A/C) HIGH-SPEED DUAL 1-OF-4 DECODER

FEATURES

- Function, Pinout, and Drive Compatible with the FCT and F Logic
- FCT-C speed at 4.8ns max. (Com'l)
FCT-A speed at 5.9ns max. (Com'l)
- CMOS V_{OH} Levels for Low Power Consumption
— Typically 1/3 of FAST Bipolar Logic
- Edge-rate Control Circuitry for Significantly Improved Noise Characteristics
- ESD protection exceeds 2000V
- Inputs and Outputs Interface Directly with TTL, NMOS, and CMOS Devices
- Outputs Meet Levels Required for CMOS Static RAM Low Power Standby Mode
- 64 mA Sink Current (Com'l), 48 mA (MII)
15 mA Source Current (Com'l), 12 mA (MII)
- Dual 1-of-4 Decoder with Enable
- Manufactured in 0.8 micron PACE Technology™

DESCRIPTION

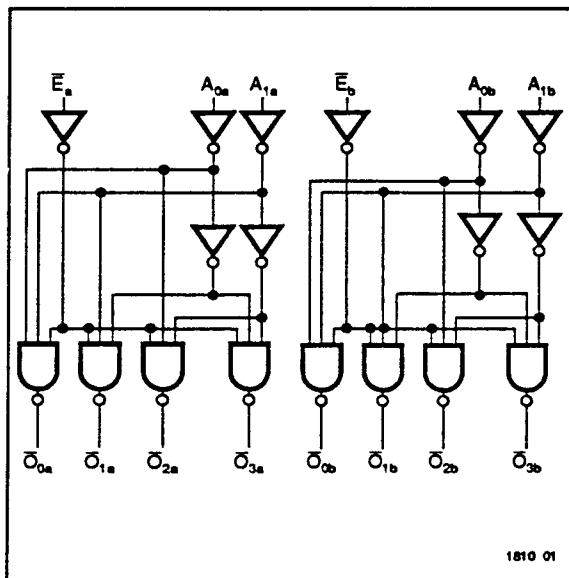
The 'FCT139 are dual 1-of-4 decoder which has two independent decoders, each of which accept two binary weighted inputs ($A_0 - A_1$) and provide four mutual exclusive active LOW outputs ($\bar{O}_0 - \bar{O}_3$). Each decoder has an active LOW enable (E). When \bar{E} is HIGH, all outputs are forced HIGH.

The 'FCT139 is manufactured using PACE Technology™ which is Performance Advanced CMOS Engineered to

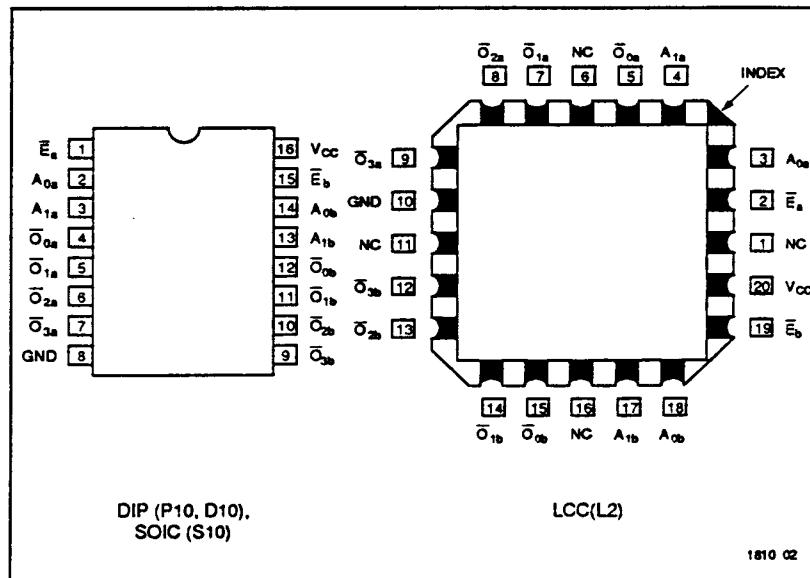
use 0.8 micron effective channel lengths giving 500 picoseconds loaded* internal gate delays. PACE Technology includes two-level metal and epitaxial substrates. In addition to very high performance and very high density, the technology features latch-up protection, single event upset protection, and is supported by a Class 1 environment volume production facility.

*For a fan-in/fan-out of 4, at 85°C junction temperature and 5.0V.

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATIONS



ABSOLUTE MAXIMUM RATINGS^{1,2}

Symbol	Parameter	Value	Unit
T _{STG}	Storage Temperature	-65 to +150	°C
T _A	Ambient Temperature Under Bias	-65 to +135	°C
V _{CC}	V _{CC} Potential to Ground	-0.5 to +7.0	V
I _{IN}	Input Current	-30 to +5.0	mA

Notes:

1810 Tbl 01

1. Operation beyond the limits set forth in the above table may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.

1810 Tbl 02

2. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.

RECOMMENDED OPERATING CONDITIONS

Free Air Ambient Temperature	Min	Max
Military Commercial	-55°C 0°C	+125°C +70°C

1810 Tbl 03

Supply Voltage (V _{CC})	Min	Max
Military Commercial	+4.5V +4.75V	+5.5V +5.25V

1810 Tbl 04

DC ELECTRICAL CHARACTERISTICS (Over recommended operating conditions)

Symbol	Parameter		Min	Typ ¹	Max	Units	V _{CC}	Conditions
V _{IH}	Input HIGH Voltage		2.0			V		
V _{IL}	Input LOW Voltage				0.8	V		
V _H	Hysteresis			0.35		V		All inputs
V _{CD}	Input Clamp Diode Voltage			-0.7	-1.2	V	MIN	I _{IN} = -18mA
V _{OH}	Output HIGH Voltage	V _{CC} = 3V, V _{IN} = 0.2V, or V _{CC} - 0.2V	V _{CC} - 0.2	V _{CC}		V		I _{OH} = -32μA
		Military/Commercial (CMOS)	V _{CC} - 0.2	V _{CC}		V	MIN	I _{OH} = -300μA
		Military (TTL)	2.4	4.3		V	MIN	I _{OH} = -12mA
		Commercial (TTL)	2.4	4.3		V	MIN	I _{OH} = -15mA
V _{OL}	Output LOW Voltage	V _{CC} = 3V, V _{IN} = 0.2V, or V _{CC} - 0.2V		GND	0.2	V		I _{OL} = 300μA
		Military/Commercial (CMOS) ³		GND	0.2	V	MIN	I _{OL} = 300μA
		Military (TTL)	0.3	0.5		V	MIN	I _{OL} = 32mA
		Commercial (TTL)	0.3	0.5		V	MIN	I _{OL} = 48mA
		Commercial (TTL)	0.3	0.5		V	MIN	I _{OL} = 64mA
I _{IH}	Input HIGH Current				5	μA	MAX	V _{IN} = V _{CC}
I _{IL}	Input LOW Current				-5	μA	MAX	V _{IN} = GND
I _{IH}	Input HIGH Current ³				5	μA	MAX	V _{OUT} = 2.7V
I _{IL}	Input LOW Current ³				-5	μA	MAX	V _{OUT} = 0.5V
I _{OS}	Output Short Circuit Current ²	-60	-120			mA	MAX	V _{OUT} = 0.0V
C _{IN}	Input Capacitance ³			5	10	pF		All inputs
C _{OUT}	Output Capacitance ³			9	12	pF		All outputs

1810 Tbl 05

Notes:

1. Typical limits are at V_{CC} = 5.0V, T_A = +25°C ambient.
2. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect

operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

3. This parameter is guaranteed but not tested.

DC CHARACTERISTICS (Over recommended operating conditions unless otherwise specified.)

Symbol	Parameter	Typ ¹	Max	Units	Conditions
I _{cc}	Quiescent Power Supply Current (CMOS inputs)	0.003	0.5	mA	V _{cc} = MAX, f ₁ = 0, Outputs Open, V _{IN} ≤ 0.2V or V _{IN} ≥ V _{cc} - 0.2V
ΔI _{cc}	Quiescent Power Supply Current (TTL inputs)	0.5	2.0	mA	V _{cc} = MAX, V _{IN} = 3.4V ² , f ₁ = 0, Outputs Open
I _{CCD}	Dynamic Power Supply Current ³	0.15	0.3	mA/mHz	V _{cc} = MAX, One Input Toggling, 50% Duty Cycle, Outputs Open, V _{IN} ≤ 0.2V or V _{IN} ≥ V _{cc} - 0.2V
I _c	Total Power Supply Current ⁵	1.7	4.5	mA	V _{cc} = MAX, f ₁ = 10 MHz, 50% Duty Cycle, Outputs Open, One Input Toggling, and V _{IN} ≤ 0.2V or V _{IN} ≥ V _{cc} - 0.2V
		2.0	5.5	mA	V _{cc} = MAX, f ₁ = 10 MHz, 50% Duty Cycle, Outputs Open, One Input Toggling, and V _{IN} = 3.4V or V _{IN} = GND
		3.2	7.5	mA	V _{cc} = MAX, f ₁ = 10 MHz, 50% Duty Cycle, Outputs Open, One Input Toggling on Each Decoder, and V _{IN} ≤ 0.2V or V _{IN} ≥ V _{cc} - 0.2V
		3.7	9.5	mA	V _{cc} = MAX, f ₁ = 10 MHz, 50% Duty Cycle, Outputs Open, One Input Toggling on Each Decoder, and V _{IN} = 3.4V or V _{IN} = GND

Notes:

1. Typical values are at V_{cc} = 5.0V, +25°C ambient and maximum loading.
2. Per TTL driven input (V_{IN} = 3.4V); all other inputs at V_{cc} or GND.
3. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
4. Values for these conditions are examples of the I_{cc} formula. These limits are guaranteed but not tested.
5. I_c = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}
 I_c = I_{cc} + ΔI_{cc}D_HN_T + I_{CCD}(f₀/2 + f₁N₁)
 I_{cc} = Quiescent Current with CMOS input levels

1810 Tbl 06

ΔI_{cc} = Power Supply Current for a TTL High Input
(V_{IN} = 3.4V)

D_H = Duty Cycle for TTL Inputs HighN_T = Number of TTL Inputs at D_HI_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)f₀ = Clock Frequency for Register Devices (Zero for Non-Register Devices)f₁ = Input FrequencyN₁ = Number of Inputs at f₁

All currents are in millamps and all frequencies are in megahertz.

TRUTH TABLE

Inputs			Outputs			
E	A ₀	A ₁	̄O ₀	̄O ₁	̄O ₂	̄O ₃
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	H	L	H	L	H	H
L	L	H	H	H	L	H
L	H	H	H	H	H	L

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

1810 Tbl 07

AC CHARACTERISTICS

Sym	Parameter	'FCT139				'FCT139A				'FCT139C				Units	Fig. No.		
		MIL		COM'L		MIL		COM'L		MIL		COM'L					
		Min. ¹	Max.														
t_{PLH}	Prop Delay A_0 or A_1 to \bar{O}_n	1.5	12.0	1.5	9.0	1.5	7.8	1.5	5.9	1.5	6.6	1.5	4.8	ns	1, 5		
t_{PHL}	Prop Delay \bar{E}_1 or \bar{E}_2 to \bar{O}_n	1.5	9.0	1.5	8.0	1.5	7.2	1.5	5.5	1.5	6.2	1.5	5.0	ns	1, 5		

Note:

1. Minimum limits are guaranteed but not tested on Propagation Delays.

1810 Tbl 08

DEFINITION OF FUNCTIONAL TERMS

Pin Names	Description
A_0, A_1	Address Inputs
\bar{E}_a, \bar{E}_b	Enable Inputs (Active LOW)
$\bar{O}_0-\bar{O}_3$	Outputs (Active LOW)

1810 Tbl 08

ORDERING INFORMATION

PxxFCT Temp. Class	xxxx Device type	xx Package	x Processing				
				Blank	Commercial		
				M	Military Temperature		
				MB	MIL-STD-883, Class B		
				P	Plastic DIP		
				D	CERDIP		
				SO	Small Outline IC		
				L	Leadless Chip Carrier		
				139	Dual 1-of-4 Decoder		
				139A	Fast Dual 1-of-4 Decoder		
				139C	Very Fast Dual 1-of-4 Decoder		
				74	Commercial		
				54	Military		

1810 03

032271 ✓ - R